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DATA SHEET

BFG35
NPN 4 GHz wideband transistor

Product specification
Supersedes data of 1995 Sep 12

1999 Aug 24

Philips
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NPN 4 GHz wideband transistor BFG35

DESCRIPTION

NPN planar epitaxial transistor mounted in a plastic SOT223 envelope, intended for wideband amplifier applications. It features high output voltage capabilities.

PINNING

PIN	DESCRIPTION
1	emitter
2	base
3	emitter
4	collector

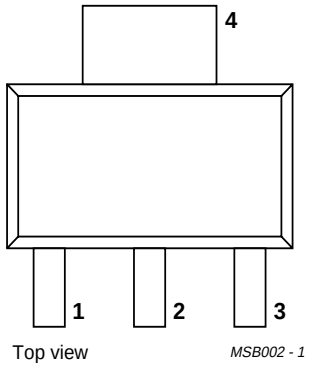


Fig.1 SOT223.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{CEO}	collector-emitter voltage	open base	–	–	18	V
I_C	DC collector current		–	–	150	mA
P_{tot}	total power dissipation	up to T_s = 135 °C (note 1)	–	–	1	W
h_{FE}	DC current gain	I_C = 100 mA; V_{CE} = 10 V; T_j = 25 °C	25	70	–	
f_T	transition frequency	I_C = 100 mA; V_{CE} = 10 V; f = 500 MHz; T_{amb} = 25 °C	–	4	–	GHz
G_{UM}	maximum unilateral power gain	I_C = 100 mA; V_{CE} = 10 V; f = 500 MHz; T_{amb} = 25 °C	–	15	–	dB
		I_C = 100 mA; V_{CE} = 10 V; f = 800 MHz; T_{amb} = 25 °C	–	11	–	dB
V_o	output voltage	I_C = 100 mA; V_{CE} = 10 V; d_{im} = –60 dB; R_L = 75 Ω; $f_{(p+q-r)}$ = 793.25 MHz; T_{amb} = 25 °C	–	750	–	mV

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	25	V
V_{CEO}	collector-emitter voltage	open base	–	18	V
V_{EBO}	emitter-base voltage	open collector	–	2	V
I_C	DC collector current		–	150	mA
P_{tot}	total power dissipation	up to T_s = 135 °C (note 1)	–	1	W
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	175	°C

Note

1. T_s is the temperature at the soldering point of the collector tab.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j\text{-}s}$	thermal resistance from junction to soldering point	up to T_s = 135 °C (note 1)	40	K/W

Note

1. T_s is the temperature at the soldering point of the collector tab.

CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	I_E = 0; V_{CB} = 10 V	–	–	1	μA
h_{FE}	DC current gain	I_C = 100 mA; V_{CE} = 10 V	25	70	–	
C_c	collector capacitance	$I_E = i_e$ = 0; V_{CB} = 10 V; f = 1 MHz	–	2	–	pF
C_e	emitter capacitance	$I_C = i_c$ = 0; V_{EB} = 0.5 V; f = 1 MHz	–	10	–	pF
C_{re}	feedback capacitance	I_C = 0; V_{CE} = 10 V; f = 1 MHz	–	1.2	–	pF
f_T	transition frequency	I_C = 100 mA; V_{CE} = 10 V; f = 500 MHz; T_{amb} = 25 °C	–	4	–	GHz
G_{UM}	maximum unilateral power gain (note 1)	I_C = 100 mA; V_{CE} = 10 V; f = 500 MHz; T_{amb} = 25 °C	–	15	–	dB
		I_C = 100 mA; V_{CE} = 10 V; f = 800 MHz; T_{amb} = 25 °C	–	11	–	dB
V_o	output voltage	note 2	–	750	–	mV
		note 3	–	800	–	mV
d_2	second order intermodulation distortion	note 4	–	–55	–	dB
		note 5	–	–57	–	dB

Notes

1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1-|s_{11}|^2)(1-|s_{22}|^2)}$ dB.
2. d_{im} = –60 dB (DIN 45004B); I_C = 100 mA; V_{CE} = 10 V; R_L = 75 Ω; T_{amb} = 25 °C
   $V_p = V_o$ at d_{im} = –60 dB; f_p = 795.25 MHz;
   $V_q = V_o$ –6 dB; f_q = 803.25 MHz;
   $V_r = V_o$ –6 dB; f_r = 805.25 MHz;
   measured at $f_{(p+q-r)}$ = 793.25 MHz.
3. d_{im} = –60 dB (DIN 45004B); I_C = 100 mA; V_{CE} = 10 V; R_L = 75 Ω; T_{amb} = 25 °C
   $V_p = V_o$ at d_{im} = –60 dB; f_p = 445.25 MHz;
   $V_q = V_o$ –6 dB; f_q = 453.25 MHz;
   $V_r = V_o$ –6 dB; f_r = 455.25 MHz;
   measured at $f_{(p+q-r)}$ = 443.25 MHz.
4. I_C = 60 mA; V_{CE} = 10 V; R_L = 75 Ω;
   $V_p = V_q = V_o$ = 50 dBmV;
   $f_{(p+q)}$ = 450 MHz; f_p = 50 MHz; f_q = 400 MHz.
5. I_C = 60 mA; V_{CE} = 10 V; R_L = 75 Ω;
   $V_p = V_q = V_O$ = 50 dBmV;
   $f_{(p+q)}$ = 810 MHz; f_p = 250 MHz; f_q = 560 MHz.

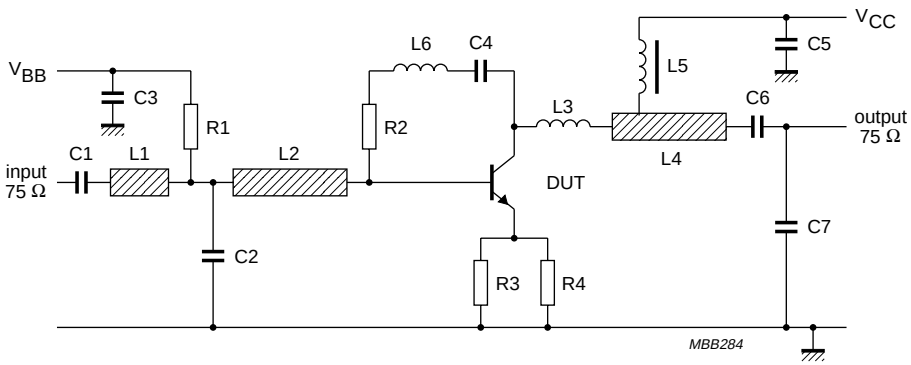


Fig.2 Intermodulation and second harmonic test circuit.

List of components (see test circuit)

DESIGNATION	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C3, C5, C6	multilayer ceramic capacitor	10 nF		2222 590 08627
C2, C7	multilayer ceramic capacitor	1 pF		2222 851 12108
C4 (note 1)	miniature ceramic plate capacitor	10 nF		2222 629 08103
L1	microstrip line	75 Ω	length 7mm; width 2.5 mm	
L2	microstrip line	75 Ω	length 22mm; width 2.5 mm	
L3 (note 1)	1.5 turns 0.4 mm copper wire		int. dia. 3 mm; winding pitch 1 mm	
L4	microstripline	75 Ω	length 19 mm; width 2.5 mm	
L5	Ferroxcube choke	5 μH		3122 108 20153
L6 (note 1)	0.4 mm copper wire	≈25 nH	length 30 mm	
R1	metal film resistor	10 kΩ		2322 180 73103
R2 (note 1)	metal film resistor	200 Ω		2322 180 73201
R3, R4	metal film resistor	27 Ω		2322 180 73279

Note

1. Components C4, L3, L6 and R2 are mounted on the underside of the PCB.
   The circuit is constructed on a double copper-clad printed circuit board with PTFE dielectric (ε_r = 2.2); thickness $^1/_{16}$ inch; thickness of copper sheet $^1/_{32}$ inch.

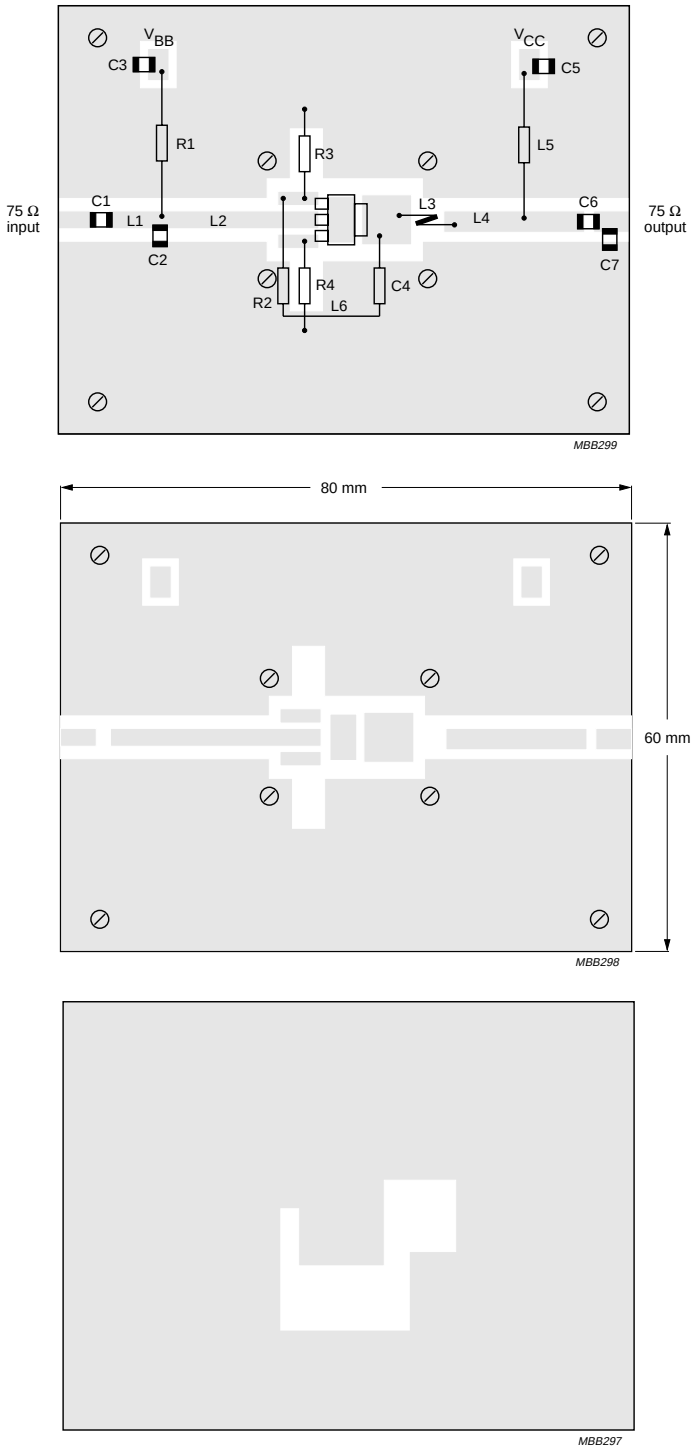


Fig.3 Intermodulation test circuit printed circuit board.

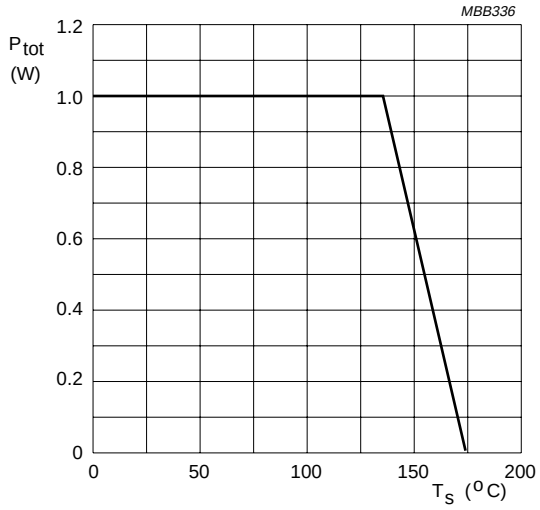
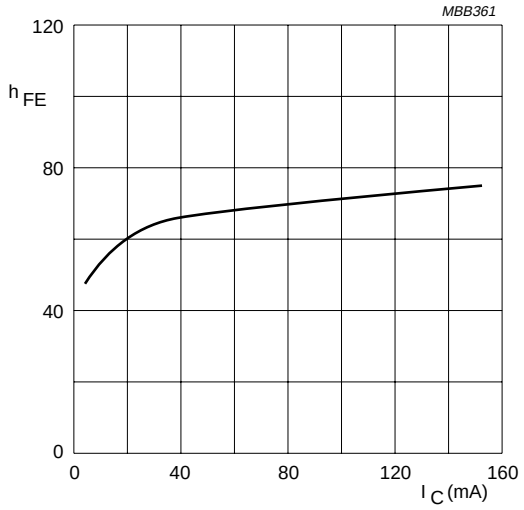
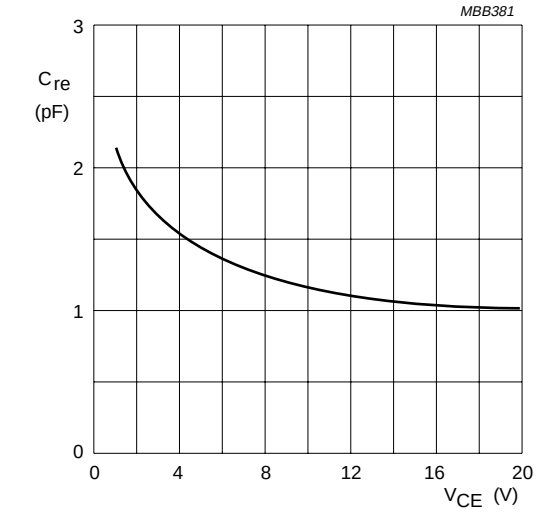


Fig.4 Power derating curve.



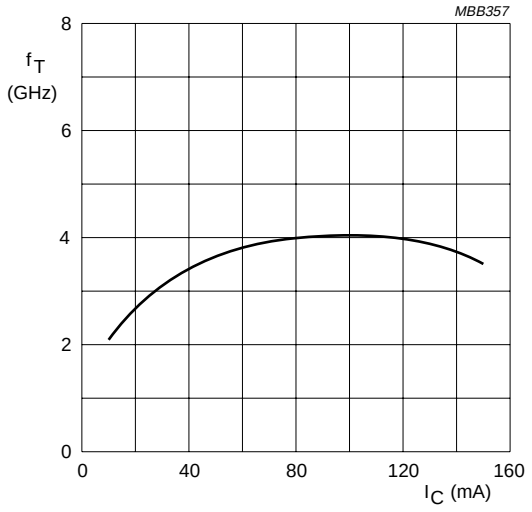
V_{CE} = 10 V; T_j = 25 °C.

Fig.5 DC current gain as a function of collector current.



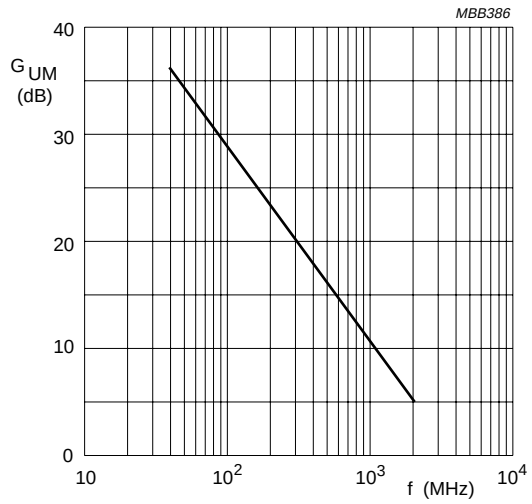
I_E = 0; f = 1 MHz; T_j = 25 °C.

Fig.6 Feedback capacitance as a function of collector-emitter voltage.



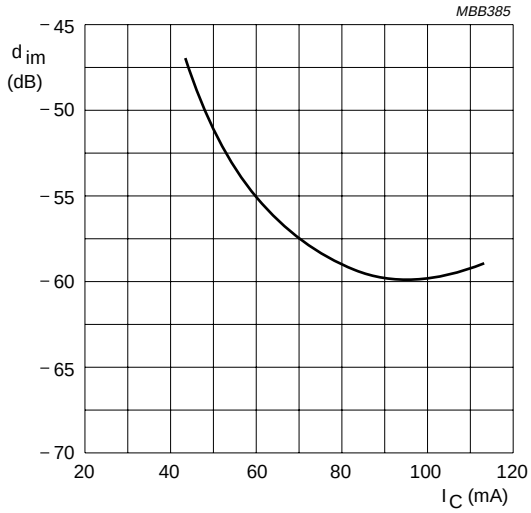
V_{CE} = 10 V; f = 500 MHz; T_j = 25 °C

Fig.7 Transition frequency as a function of collector current.



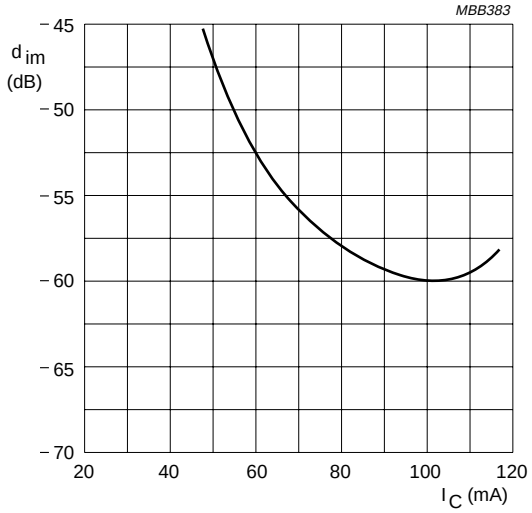
I_C = 100 mA; V_{CE} = 10 V; T_{amb} = 25 °C.

Fig.8 Maximum unilateral power gain as a function of frequency.



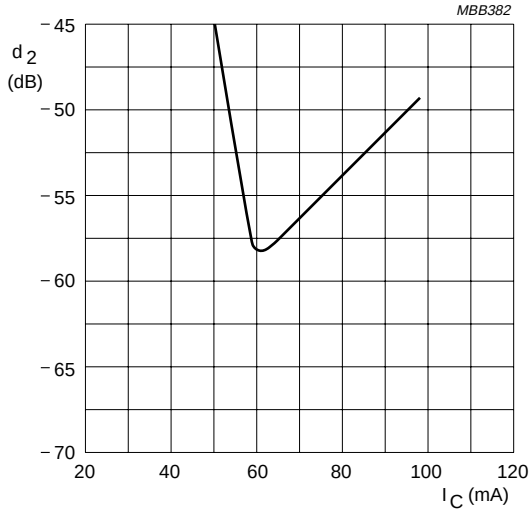
V_{CE} = 10 V; V_o = 800 mV; $f_{(p+q-r)}$ = 443.25 MHz; T_{amb} = 25 °C.

Fig.9 Intermodulation distortion as a function of collector current.



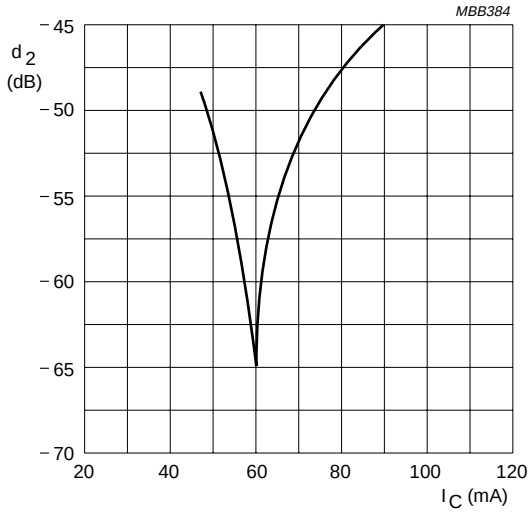
V_{CE} = 10 V; V_o = 750 mV; $f_{(p+q-r)}$ = 793.25 MHz; T_{amb} = 25 °C.

Fig.10 Intermodulation distortion as a function of collector current.



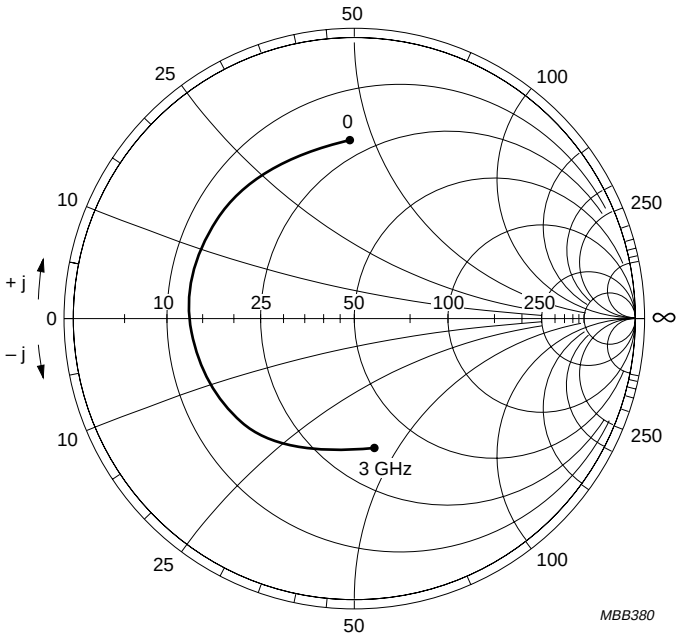
V_{CE} = 10 V; V_o = 50 dBmV; $f_{(p+q)}$ = 450 MHz; T_{amb} = 25 °C.

Fig.11 Second order intermodulation distortion as a function of collector current.



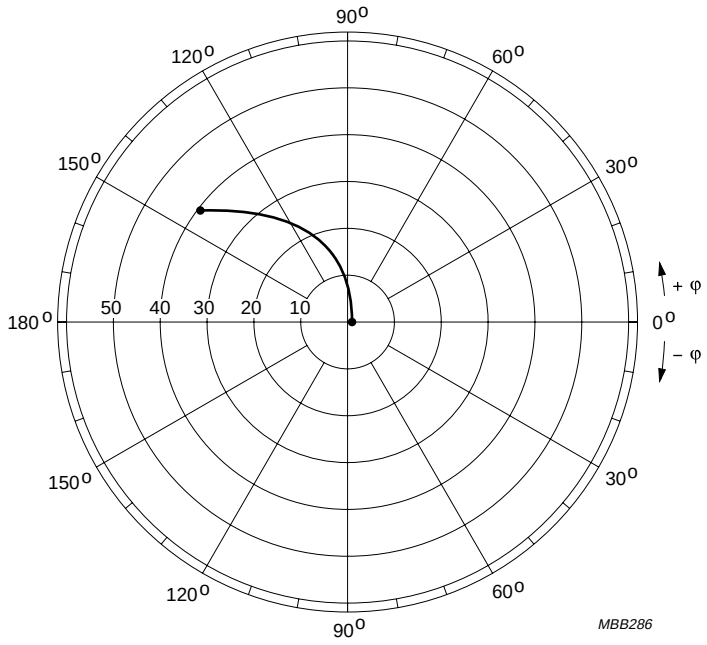
V_{CE} = 10 V; V_o = 50 dBmV; $f_{(p+q)}$ = 810 MHz; T_{amb} = 25 °C.

Fig.12 Second order intermodulation distortion as a function of collector current.



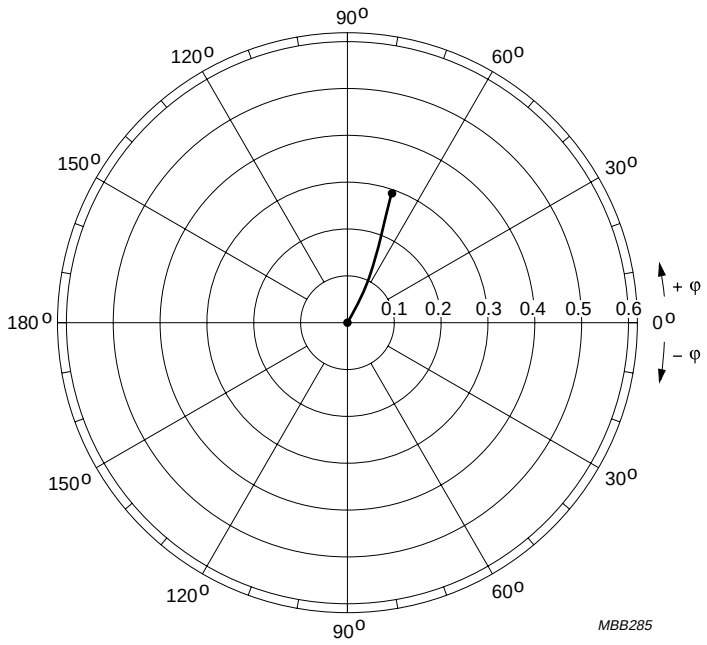
I_C = 100 mA; V_{CE} = 10 V; T_{amb} = 25 °C; Z_o = 50 Ω.

Fig.13 Common emitter input reflection coefficient (S_{11}).



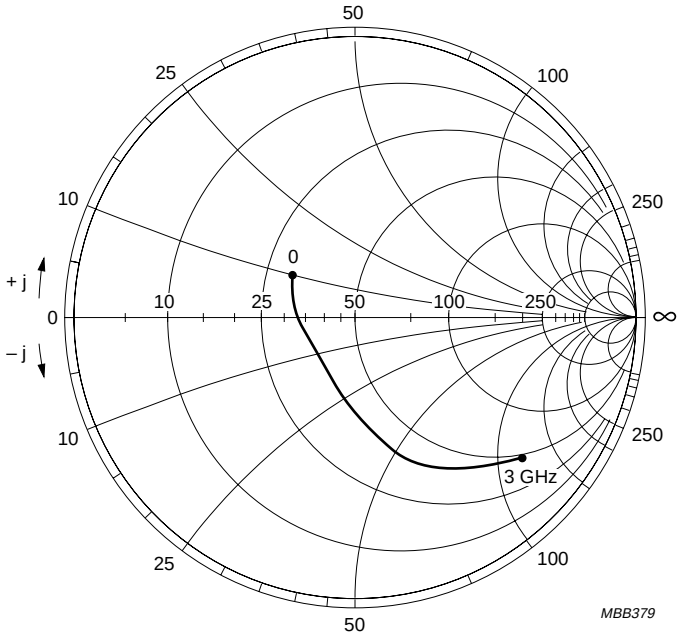
I_C = 100 mA; V_{CE} = 10 V; T_{amb} = 25 °C.

Fig.14 Common emitter forward transmission coefficient (S_{21}).



I_C = 100 mA; V_{CE} = 10 V; T_{amb} = 25 °C.

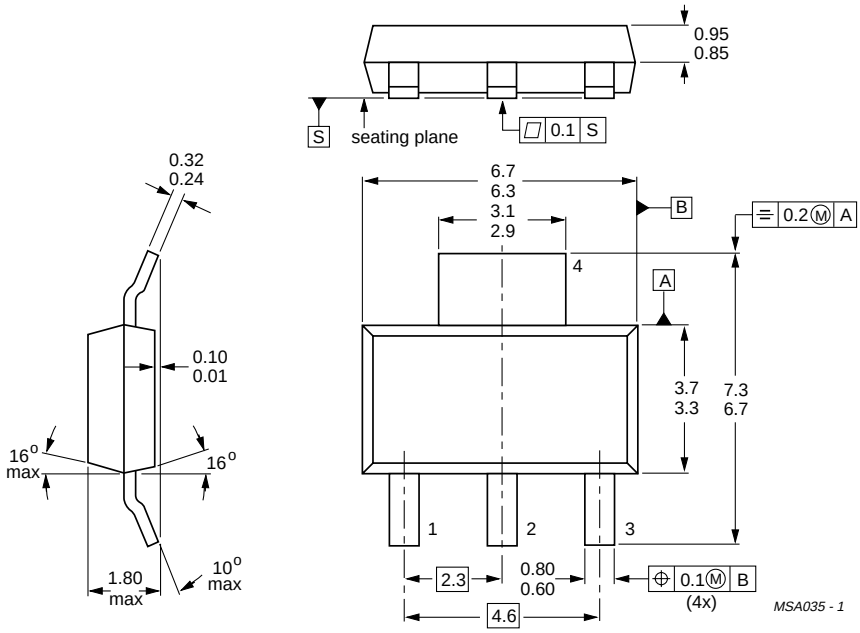
Fig.15 Common emitter reverse transmission coefficient (S_{12}).



I_C = 100 mA; V_{CE} = 10 V; T_{amb} = 25 °C; Z_o = 50 Ω.

Fig.16 Common emitter output reflection coefficient (S_{22}).

PACKAGE OUTLINE



Dimensions in mm.

Fig.17 SOT223.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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Argentina: see South America

Australia: 3 Figtree Drive, HOMEBUSH, NSW 2140,
Tel. +61 2 9704 8141, Fax. +61 2 9704 8139

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213,
Tel. +43 1 60 101 1248, Fax. +43 1 60 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 20 0733, Fax. +375 172 20 0773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 68 9211, Fax. +359 2 68 9102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381, Fax. +1 800 943 0087

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Sydhavnsgade 23, 1780 COPENHAGEN V,
Tel. +45 33 29 3333, Fax. +45 33 29 3905

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615 800, Fax. +358 9 6158 0920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 4099 6161, Fax. +33 1 4099 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 2353 60, Fax. +49 40 2353 6300

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: PT Philips Development Corporation, Semiconductors Division,
Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510,
Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Via Casati, 23 - 20052 MONZA (MI),
Tel. +39 039 203 6838, Fax +39 039 203 6800

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku,
TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5057

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381, Fax +9-5 800 943 0087

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Pakistan: see Singapore

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 319762,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 58088 Newville 2114,
Tel. +27 11 471 5401, Fax. +27 11 471 5398

South America: Al. Vicente Pinzon, 173, 6th floor,
04547-130 SÃO PAULO, SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 93 301 6312, Fax. +34 93 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 5985 2000, Fax. +46 8 5985 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2741 Fax. +41 1 488 3263

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2886, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,
Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Yukari Dudullu, Org. San. Blg., 2.Cad. Nr. 28 81260 Umraniye,
ISTANBUL, Tel. +90 216 522 1500, Fax. +90 216 522 1813

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 208 730 5000, Fax. +44 208 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381, Fax. +1 800 943 0087

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Tel. +381 11 62 5344, Fax.+381 11 63 5777

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International Marketing & Sales Communications, Building BE-p, P.O. Box 218,
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